

Fig. 5 TSMC 40nm die micrograph of full-duplex transceiver.

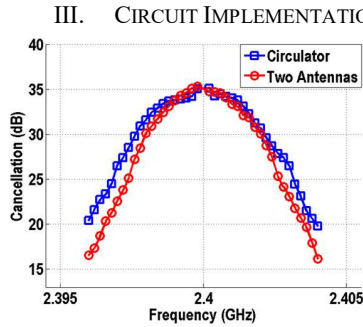


Fig. 6 Measurement results of TX leakage suppression versus bandwidth using both a circulator and two antennas.

As a demonstration of the proposed SI canceler system, a transceiver front-end is designed to have performance similar to that of a Bluetooth radio, with the exception of enabling an FD feature, Fig. 4. The differential input of the SI canceler is attached to the primary side of the TX output transformer, to provide SI cancellation at the LNA input. A switch-capacitor PA (SCPA) is implemented with a harmonic-reject feature. The RX utilizes a noise-canceling current-mode architecture to improve the out-of-band linearity. An integrated divide-by-two circuit generates a 25% duty cycle LO which drives the mixers.

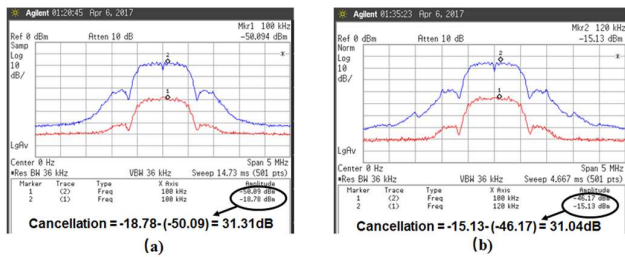


Fig. 7 Measured TX suppression using a modulated GFSK signal. Baseband output spectrum with cancellation enabled/disabled, (a) measurement with a circulator, (b) measurement with two antennas.

IV. MEASUREMENT RESULTS

This chip is fabricated in a TSMC 40nm CMOS process with a six-layer metal stack and a UTM layer. The die is assembled

with the test-board using chip-on-board packaging. A die photo is shown in Fig. 5. The self-interference cancellation circuitry is compact and occupies an area of less than $131\mu\text{m} \times 112.5\mu\text{m}$.

The RX operates from 1 to 3 GHz with a measured gain of 45dB, a 1.5MHz 3dB channel BW, a 4.5 dB in-band noise figure, an 18 dBm out-of-band IIP₃ and an 8.5 dBm out-of-band input P_{-1dB}. The RX consumes 10mA from a 1.1 V supply which includes 4mA from the LNA stage, 0.7mA from each of the four baseband operational amplifiers and 3mA for the LO dividers.

All SI cancellation measurements were performed using two different front-end air interface solutions, a circulator and two antennas. Both media have a measured TX-to-RX isolation of 20-30dB. The integrated PA delivers an output power of 0dBm while the SI cancellation measurements are performed. A maximum cancellation of 35dB was measured and a 30dB cancellation was achieved over a 4 MHz BW, Fig. 6. The SI cancellation was repeated with GFSK modulated signal, Fig. 7.

RX noise figure measurements were performed to characterize the canceler network, using a desired RX signal 100 kHz offset frequency from the TX signal. After the canceler is enabled, the RX NF degradation is 0.6dB, see Fig. 8.

The HR SCPA was measured with both single-tone and modulated signals. The PA has a measured +14 dBm maximum output power with a 33% drain efficiency. The measured HRPA reduction of the 3rd and 5th harmonics (Fig. 9) are 30dB and 15dB, respectively. Using a GFSK modulated input signal with the PA set to maximum output power, a 0.6% EVM was measured.

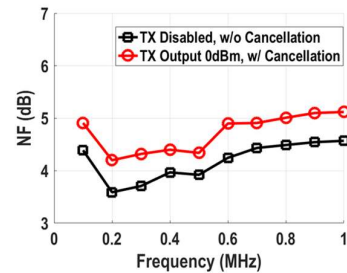


Fig. 8 Measured RX noise figure with 0 dBm PA output with the canceler enabled and disabled, relative to the baseband frequency.

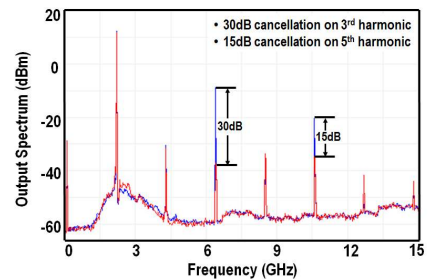


Fig. 9 Measured PA output spectrum with harmonic rejection enabled and disabled.

Table I: Comparison Table

SI Cancellation		J. Zhou' 2015 ISSCC	Van Den Broek' 2015 ISSCC	D. Yang' 2015 JSSC	N. Reiskarimian' 2017 ISSCC	T. Zhang' 2017 ISSCC	This Work
Architecture		FD Equalization	VM-Downmixer	BB Duplexing LNA	Magnetic-Free Circulator Receiver	Dual Path + Adaptive Filter	Polyphase Filter + Active Gm Stage
Technology		65nm	65nm	65nm	65nm	40nm	40nm
Cancellation BW	Cancellation(dB)	20	27	33	40 ²	50	30
	BW(MHz)	15/25 ¹	16.25	0.3	20	42	4
RX NF degradation due to TX SI cancellation (dB)		0.9-1.2/ 1.1-1.5 ¹	4-6	N/A	1.7	1.5	0.6
Max TX port operating power (dBm)		N/A	N/A	-17.3	8	15	0
Canceler IIP3 (dBm)		N/A	N/A	N/A	N/A ³	36	15
Canceller power (mW)		44-91	N/A	N/A	36	11.5	0.25
Canceller area (μm ²)		N/A	N/A	N/A	N/A	203×124(RF)+ 925×350(BB)	131×112.5

¹Measurement taken with an antenna pair. 15MHz BW, 0.9-1.2dB NF degradation is with one filter. 25MHz, 1.1-1.5dB is with two filters. ²Digital SI cancellation is not included. ³Measured TX-Antenna IIP₃ is 30dBm.

TX Harmonic Rejection	T. Sano' 2015 ISSCC	A. Ba' 2014 RFIC	This Work
Architecture	Conduction Angle Calibration	Conduction Angle Calibration	HR SCPA
Technology	40nm	40nm	40nm
Output Power (dBm)	0	1.2	14
Drain Efficiency (%)	-NA-	39	30
Off-chip Matching network	No	Yes	No
HD3 (dBc)	-48	<-50	-22.6 (before) /-51.9 (after)
HD5 (dBc)	-NA-	<-50	-31 (before) /-45.3 (after)
EVM (%)	-NA-	-NA-	0.6

A performance comparison is given in Table I. The measurement results from this prototype chip demonstrates promise toward Bluetooth-like applications using FD radios.

V. CONCLUSIONS

This paper introduces several methods to enable TX SI cancellation and TX output harmonic rejection for low-power FD radios. This effort describes a low-noise, low-power SI cancellation technique and a HRPDA which contribute toward reducing the interaction between the TX and RX in the analog front-end, to eventually realize FD radios.

ACKNOWLEDGMENT

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